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(12) **United States Design Patent**
Huang et al.

(10) **Patent No.:** **US D763,805 S**
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- (54) **LIGHT EMITTING DIODE CHIP**
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- (**) Term: **15 Years**
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Related U.S. Application Data

- (63) Continuation of application No. 29/495,848, filed on Jul. 4, 2014, now Pat. No. Des. 731,989.

(30) **Foreign Application Priority Data**

Jun. 6, 2014 (TW) 103303417

- (51) **LOC (10) Cl.** **13-03**
- (52) **U.S. Cl.**
USPC **D13/180**

(58) **Field of Classification Search**

USPC D13/180; D26/1
 CPC ... H01L 25/167; H01L 25/0753; H01L 27/15;
 H01L 27/156; H01L 31/02; H01L 33/00;
 H01L 33/04; H01L 33/08; H01L 33/10;
 H01L 33/20; H01L 33/38; H01L 33/42;
 H01L 33/48; H01L 33/62; H01L 33/483;
 H01L 33/486; F21K 9/00; F21K 9/30; F21K
 9/54

See application file for complete search history.

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(57) **CLAIM**

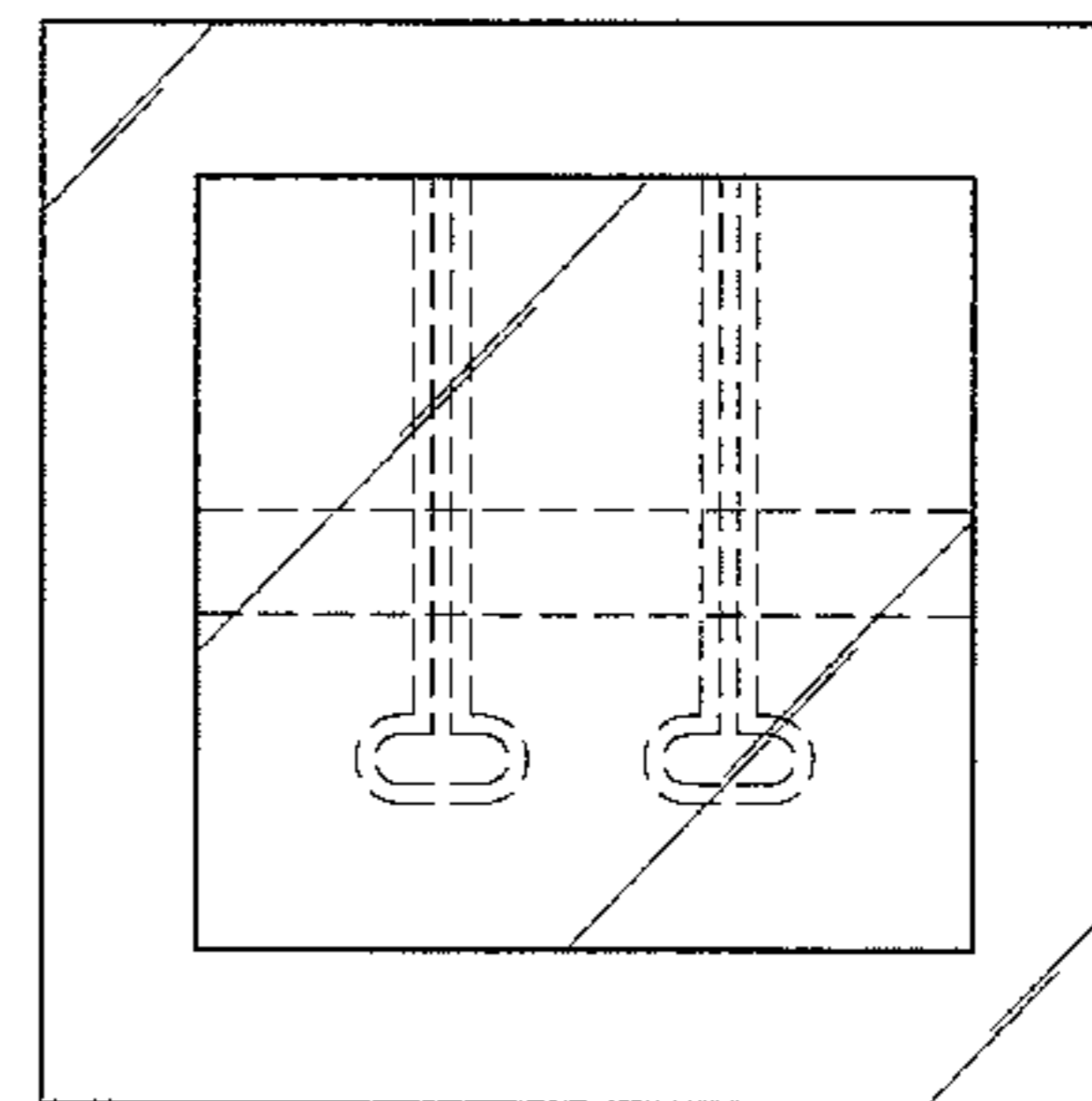
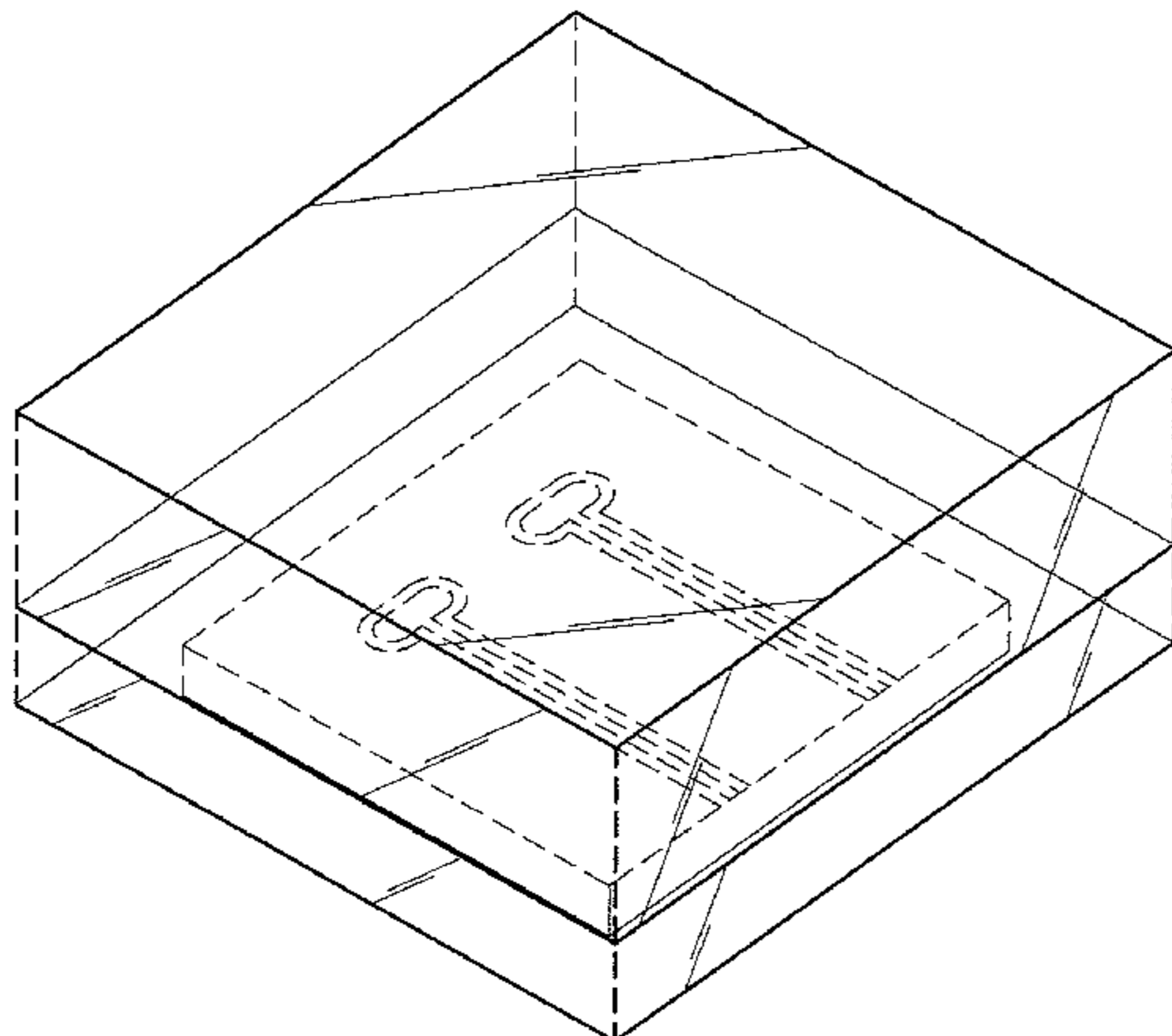
The ornamental design for a light emitting diode chip, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a light emitting diode chip showing our new design;
 FIG. 2 is a front view thereof;
 FIG. 3 is a rear view thereof;
 FIG. 4 is a left side view thereof;
 FIG. 5 is a right side view thereof;
 FIG. 6 is a top view thereof; and,
 FIG. 7 is a bottom view thereof.

The broken line portions of the light emitting diode chip represent unclaimed portions of the design and form no part thereof.

1 Claim, 4 Drawing Sheets



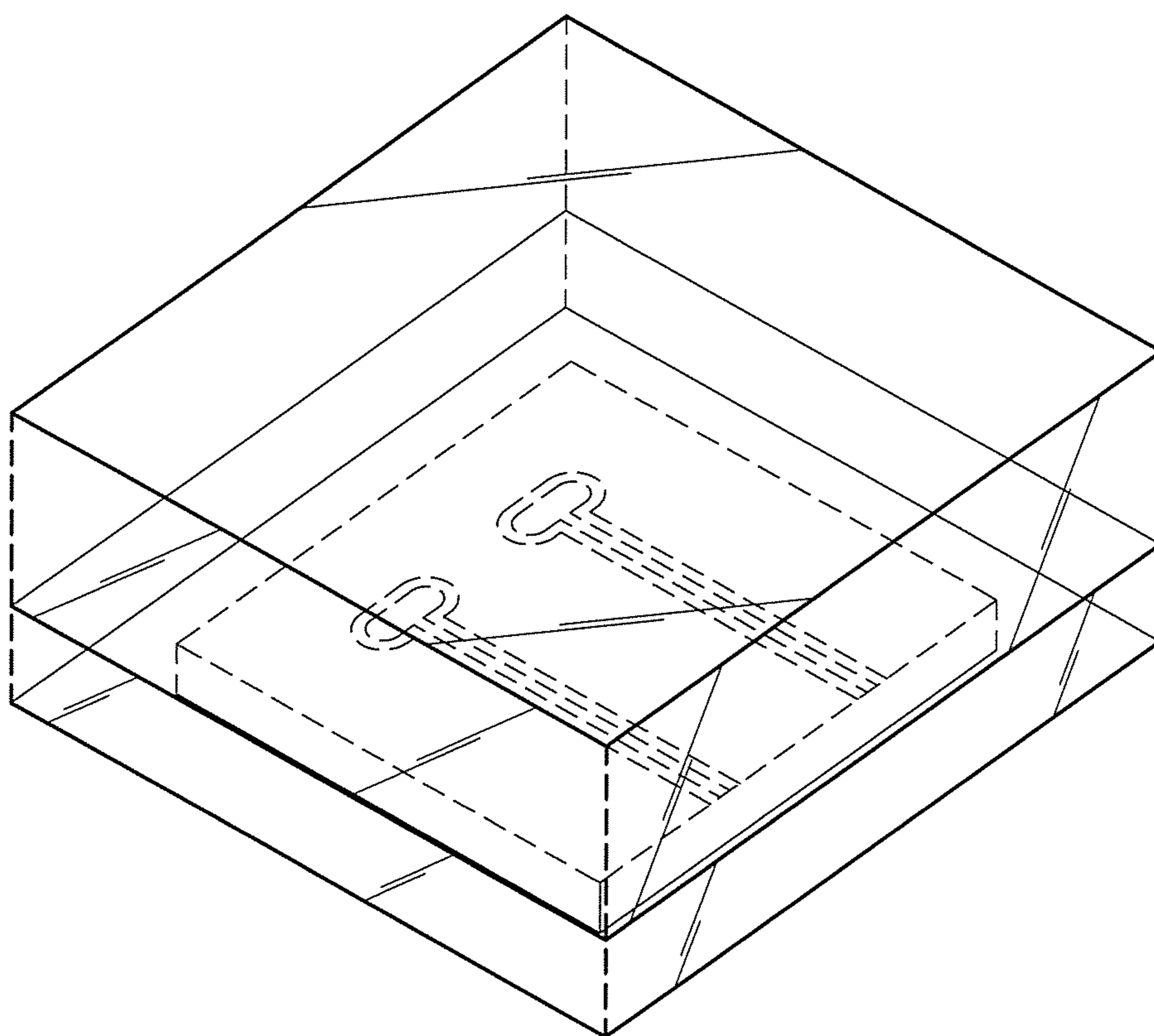


FIG. 1

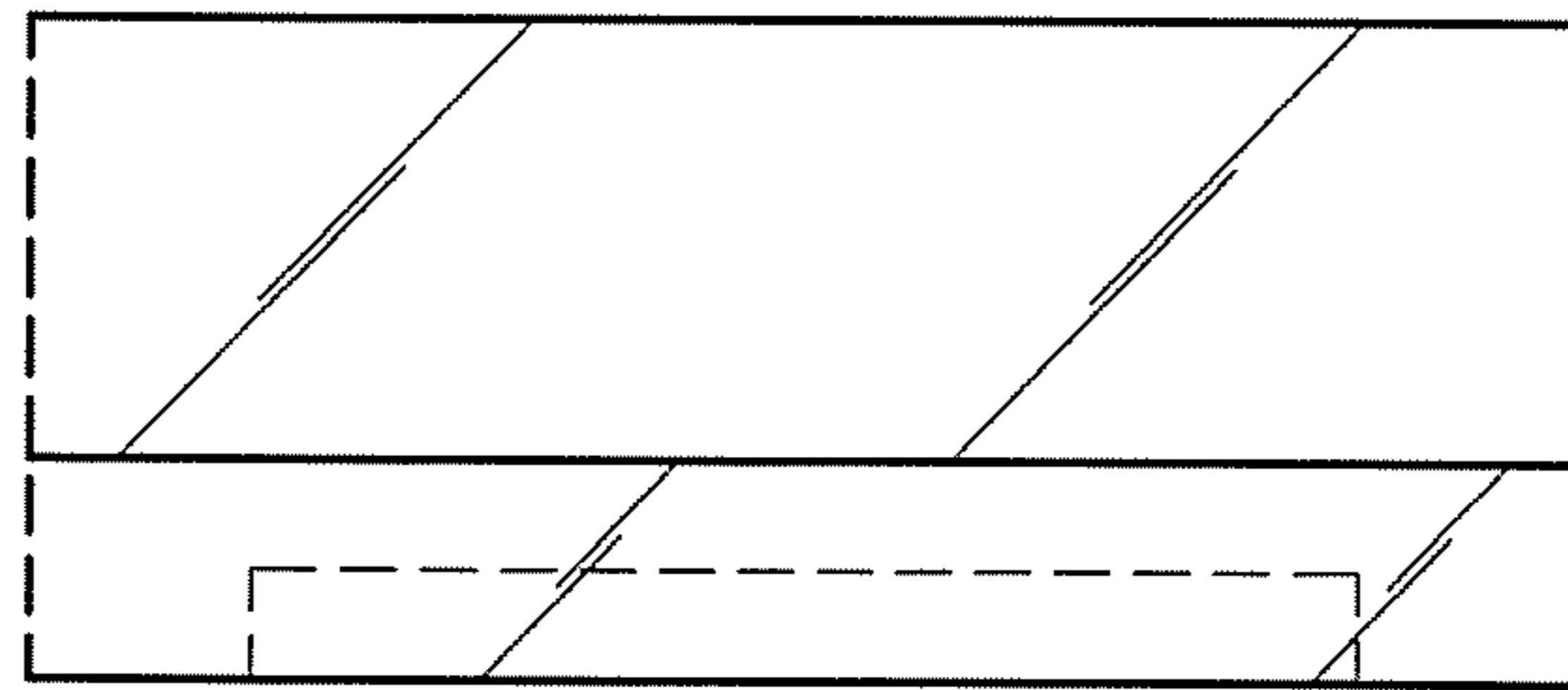


FIG. 2

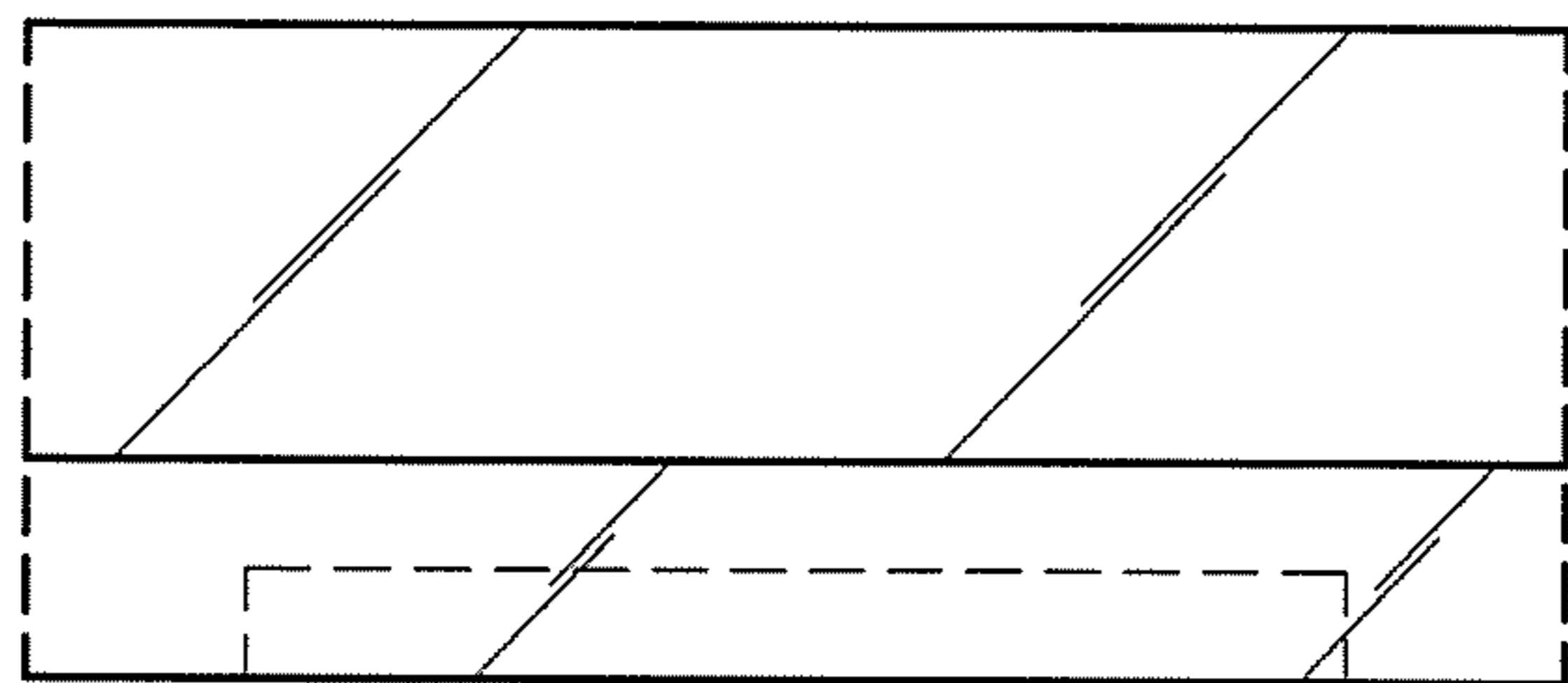


FIG. 3

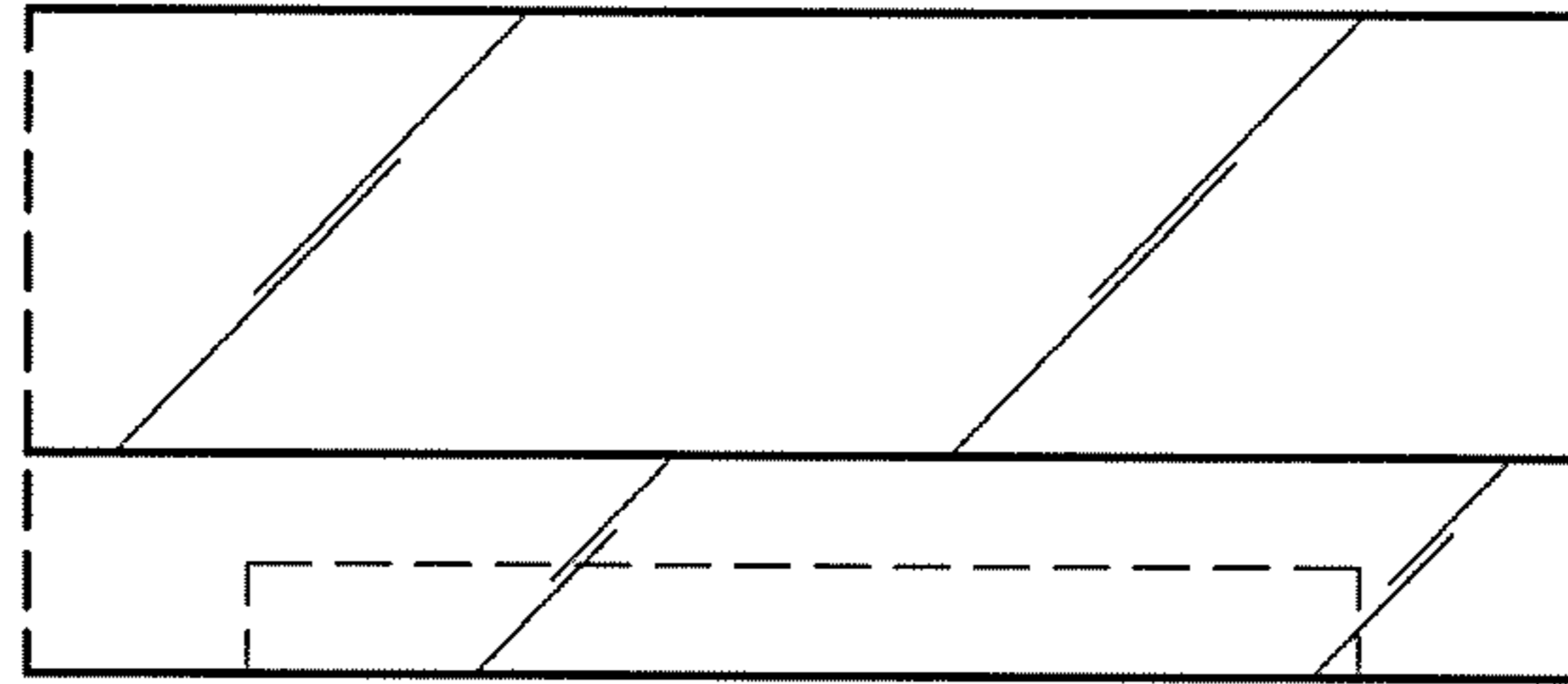


FIG. 4

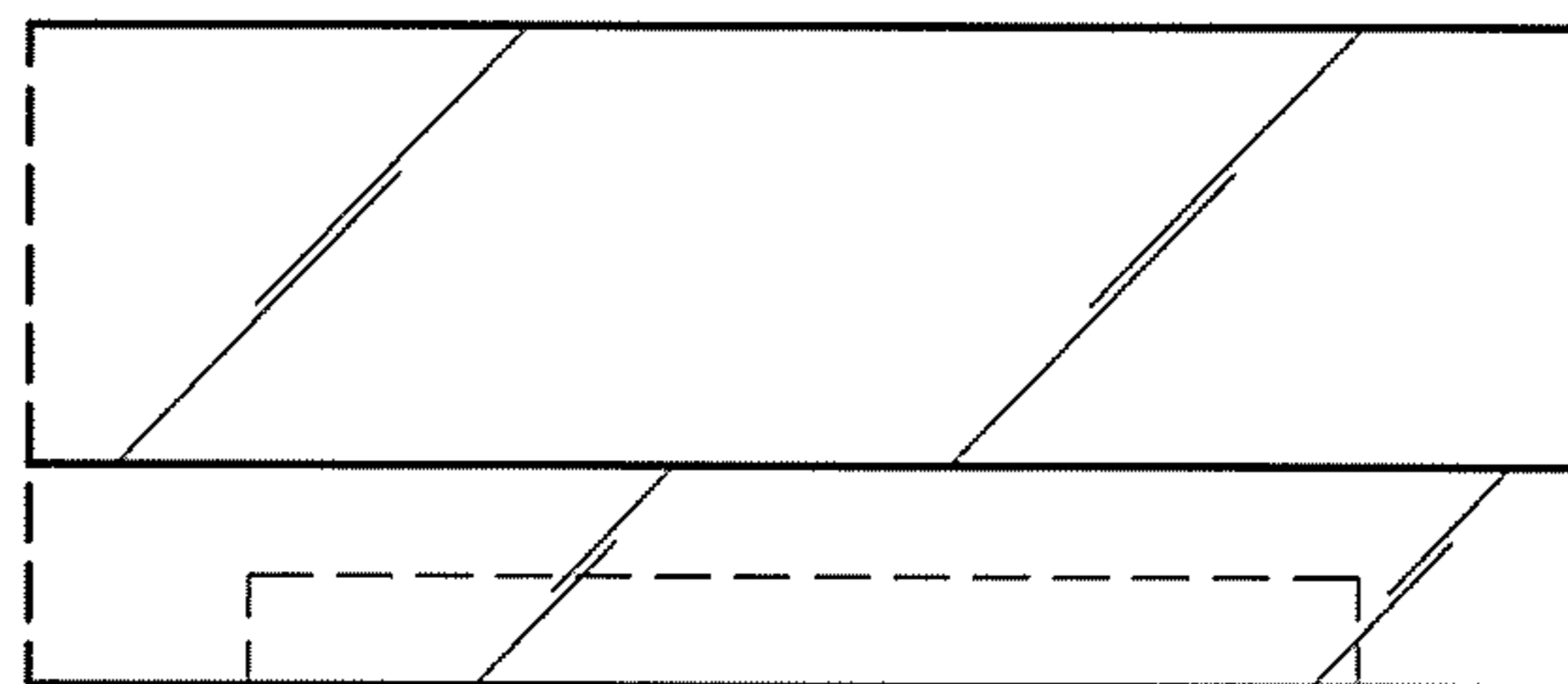


FIG. 5

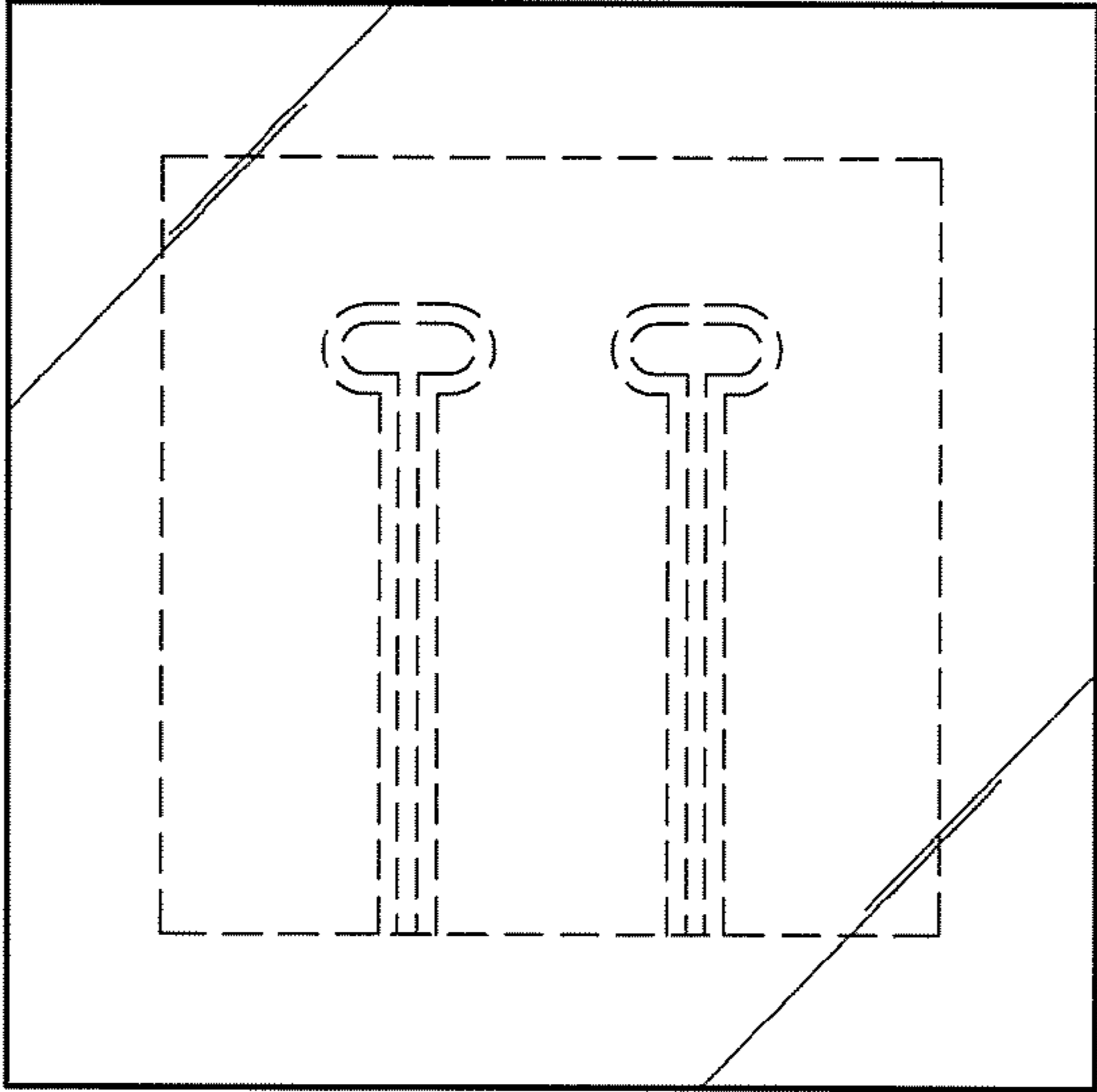


FIG. 6

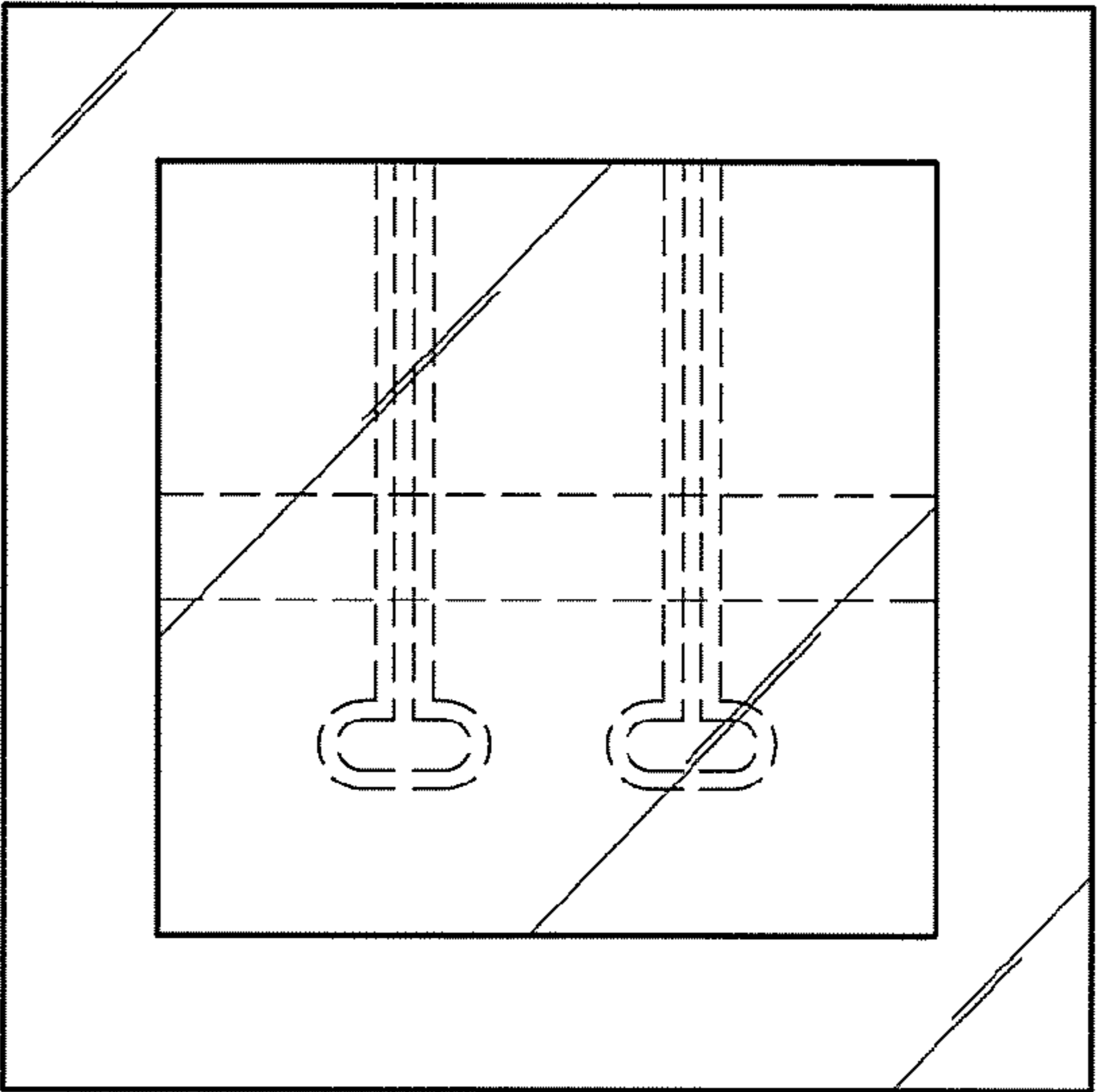


FIG. 7